



RD Number: RD198

RD Title: TC78H651AFNG Evaluation Circuit BOM

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package	Not Mount
1	IC1	1	TC78H651AFNG	TC78H651AFNG	TOSHIBA	Motor driver IC	TSSOP16	
2	C1	1	0.1 μ F	—	—	Chip capacitor		
3	J1	1	SCREW-TERMINAL-2P	—	—	SCREW-TERMINAL-2P		
4	J2	1	SCREW-TERMINAL-4P	—	—	SCREW-TERMINAL-4P		
5	J3	1	CONNECTOR-SMD	—	—	GROVE-CONNECTOR-SMD		
6	J4	1	CONNECTOR-SMD	—	—	GROVE-CONNECTOR-SMD		

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